

### STLVDS050

### High speed differential line drivers and receivers

#### Feature summary

- Meets or exceed the requirements of ansi eia/tia-644-1995 standard
- Signaling rates up to 400Mbit/s
- Bus terminal ESD exceeds 6kV
- Operates from a single 3.3V supply
- Low-voltage differential signaling with typical output voltage of 350mV and a 100Ω load
- Propagation delay times:

Driver: 2ns (typ) Receiver: 3ns (typ)

■ Power dissipation at 200MHz:

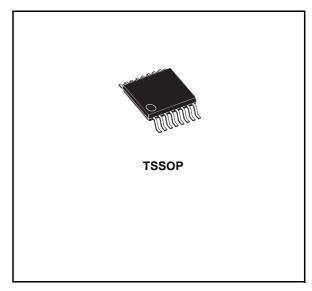
Driver: 25mW (typ) Receiver: 60mW (typ)

- LVTTL input levels are 5V tolerant
- Receiver has open-circuit fail-safe

#### **Description**

The STLVDS050 is differential line drivers and receivers that use low-voltage differential signaling (LVDS) to achieve signaling rate as high as 400Mbps.

The EIA/TIA-644 standard compliant electrical interface provides a minimum differential output voltage magnitude of 247mV into a  $100\Omega$  load and receipt of 100mV signals with up to 1V of ground potential difference between a transmitter and receiver.



The intended application of this device an signaling technique is for point-to-point baseband data transmission over controlled impedance media of approximately  $100\Omega$  characteristic impedance.

The transmission media may be printed-circuit board traces, backplanes, or cables. (Note: The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media, the noise coupling to the environment, and other application specific characteristics).

#### Order codes

Part number Temperature Range		Package	Comments	
STLVDS050BTR	-40 to 85 °C	TSSOP16 (Tape & Reel)	2500 parts per reel	

March 2006 Rev. 4 1/15

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STLVDS050 Pin configuration

# 1 Pin configuration

Figure 1. Pin connections and functional diagram

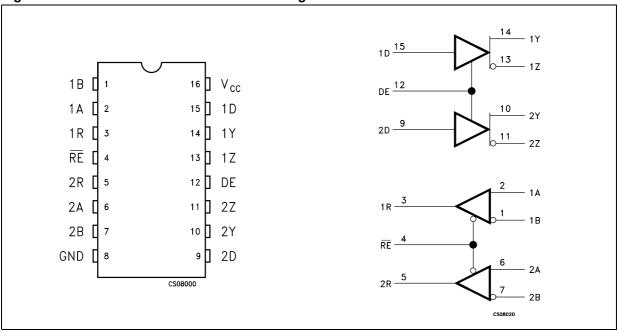


Table 1. Pin description

Pin n°	Symbol	Name and function
1,2, 6, 7	1A, 1B, 2A, 2B	Receiver inputs
3, 5	1R, 2R	Receiver outputs
4	RE	Receiver enable
9, 15	2D, 1D	Driver inputs
12	DE	Driver enable
10, 11, 13, 14	2Y, 2Z, 1Y, 1Z	Driver outputs
8	GND	Ground
16	V <sub>CC</sub>	Supply voltage

Table 2. Truth table for receiver

$V_{ID} = V_A - V_B$	RE	R
V <sub>ID</sub> ≥ 100mV	L	Н
-100mV < V <sub>ID</sub> < 100mV	L	?
$V_{ID} \le -100 mV$	L	L
OPEN	L	Н
X	Н	Z

Pin configuration STLVDS050

Table 3. Truth table for driver

D	DE	Y	Z
L	Н	L	Н
Н	Н	Н	L
OPEN	Н	L	Н
X	L	Z	Z

L=Low level, H=High Level, X=Don't care, Z= High Impedance

STLVDS050 Maximum ratings

# 2 Maximum ratings

Table 4. Absolute maximum ratings

Symbol	Parameter		Value	Unit
V <sub>CC</sub>	Supply voltage		-0.5 to 4	V
VI	Voltage range	D, R, DE, RE	-0.5 to 6	V
ESD	ESD Protection voltage (HBM)	Y, Z, A, B, and GND	± 6	kV
ESD	ESD Flotection voltage (HBM)	All Pins	± 3	KV
T <sub>STG</sub>	Storage temperature range		-65 to 150	ô

Note:

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

Table 5. Recommended operating conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
V <sub>CC</sub>	Supply voltage	3.0	3.3	3.6	V
V <sub>IH</sub>	HIGH level input voltage	2.0			V
V <sub>IL</sub>	LOW level input voltage			0.8	V
V <sub>ID</sub>	Magnitude of differential input voltage	0.1		0.6	V
V	Common mode input voltage	V <sub>ID</sub>  /2		24- V <sub>ID</sub>  /2	V
V <sub>IC</sub>				V <sub>CC</sub> -0.8	V
T <sub>A</sub>	Operating temperature range	-40		85	°C

Electrical characteristics STLVDS050

## 3 Electrical characteristics

Table 6. Electrical characteristics (Typical values are at  $T_A = 25$ °C,  $V_{CC} = 3.3$ V ±10%,  $T_A = -40$  to 85°C unless otherwise specified).

Symbol	Parameter	Test	Min.	Тур.	Max.	Unit	
I <sub>CC</sub> Supply Current	Drivers and receivers enabled, no receiver loads, driver $R_L$ =100 $\Omega$		12	20			
	Supply Current	Driver enabled, receivers disabled, $R_L$ =100 $\Omega$		10	16	mA	
		Drivers disabled, receiver enabled, no load		4	6		
		Disabled		0.5	1		

Table 7. Driver electrical characteristics (Typical values are at  $T_A$  = 25°C,  $V_{CC}$  = 3.3V ±10%,  $T_A$  = -40 to 85°C unless otherwise specified).

specified).							
Symbol	Parameter	Test		Min.	Тур.	Max.	Unit
V <sub>OD</sub>	Differential output voltage magnitude	$R_L = 100\Omega$	R <sub>L</sub> = 100Ω		340	454	mV
Δ V <sub>OD</sub>	Change in differential output voltage magnitude between logic states	R <sub>L</sub> = 100Ω		-50		50	mV
$\Delta V_{OC(SS)}$	Change in steady-state common mode output voltage between logic states			-50		50	mV
V <sub>OC(SS)</sub>	Steady-state common mode output voltage			1.125	1.2	1.375	V
V <sub>OC(PP)</sub>	Peak to peak common mode output voltage				50	150	mV
	High level input current	V - 5V	DE		-0.5	-20	μΑ
I <sub>IH</sub>	riigii ievei iiiput current	$R_{L} = 100\Omega$	D		2	20	μΑ
1	Low level input current	V = 0.8V	DE		-0.5	-10	μΑ
I <sub>IL</sub>	Low level input current	$R_{L} = 100\Omega$ $R_{L$	D		1	10	μΑ
l	Short circuit output current	$V_{O(Y)}$ or $V_{O(Z)} = 0V$			6	10	mA
l <sub>OS</sub>	Short circuit output current	V <sub>OD</sub> = 0			4	10	mA
	High impedance output current	V <sub>O</sub> = 600mV				± 1	μΑ
l <sub>OZ</sub>	riigii iiipedance odipul current	$V_O = 0V \text{ or } V_{CC}$				± 1	μΑ
I <sub>O(OFF)</sub>	Power OFF output current	$V_{CC} = 0VV_O = 3.6V$				± 1	μΑ
C <sub>IN</sub>	Input capacitance				3		pF

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Table 8. Receiver electrical characteristics (Typical values are at  $T_A = 25$ °C,  $V_{CC} = 3.3$ V ±10%,  $T_A = -40$  to 85°C unless otherwise specified).

Symbol	Parameter	Test	Min.	Тур.	Max.	Unit
V <sub>ITH+</sub>	Positive-going differential input voltage threshold				100	mV
V <sub>ITH-</sub>	Negative-going differential input voltage threshold		-100			mV
V <sub>OH</sub>	High level output voltage	I <sub>OH</sub> = -8mA	2.4			V
V <sub>OL</sub>	Low level output voltage	I <sub>OL</sub> = 2mA			0.4	V
	Input current (A or B Inputs)	V <sub>I</sub> =0V	-2	-11	-20	μΑ
l <sub>l</sub>		V <sub>I</sub> = 2.4V	-1	-3		μΑ
I <sub>I(OFF)</sub>	Power OFF input current (A or B Inputs)	V <sub>CC</sub> = 0V			±20	μА
I <sub>IH</sub>	High level input current (Enable)	V <sub>IH</sub> = 5V			±10	μΑ
I <sub>IL</sub>	Low level input current (Enable)	V <sub>IL</sub> = 0.8V			±10	μΑ
I <sub>OZ</sub>	High impedance output current	V <sub>O</sub> = 0 or 5V			± 10	μΑ
C <sub>IN</sub>	Input capacitance			3		pF

Table 9. Driver switching characteristics (Typical values are at  $T_A = 25$ °C,  $V_{CC} = 3.3$ V ±10%,  $T_A = -40$  to 85°C unless otherwise specified).

Symbol	Parameter	Test	Min.	Тур.	Max.	Unit
t <sub>PLH</sub>	Propagation delay time, low to high output			2	2.7	ns
t <sub>PHL</sub>	Propagation delay time, high to low output	R <sub>L</sub> = 100Ω C <sub>L</sub> = 10pF		2	2.7	ns
t <sub>r</sub>	Differential output signal rise time			0.4	1	ns
t <sub>f</sub>	Differential output signal fall time			0.4	1	ns
t <sub>sk(P)</sub>	Pulse skew ( t <sub>THL</sub> - t <sub>TLH</sub>  ) <sup>(1)</sup>			50		ps
t <sub>sk(O)</sub>	Channel-to-channel output skew (2)			40		ps
t <sub>PZH</sub>	Propagation delay time, high impedance to high level output			6	10	ns
t <sub>PZL</sub>	Propagation delay time, high impedance to low level output			6	10	ns
t <sub>PHZ</sub>	Propagation delay time, high level to high impedance output			3	10	ns
t <sub>PLZ</sub>	Propagation delay time, low level to high impedance output			3	10	ns

<sup>1.</sup>  $t_{sk(P)}$  is the magnitude of the time difference between the high to low and low to high propagation delay times at an output

<sup>2.</sup>  $t_{sk(O)}$  is the magnitude of the time difference between the output of a single device with all their inputs connected together

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Table 10. Receiver switching characteristics (Typical values are at  $T_A = 25$ °C,  $V_{CC} = 3.3$ V ±10%,  $T_A = -40$  to 85°C unless otherwise specified).

Symbol	Parameter	Test	Min.	Тур.	Max.	Unit
t <sub>PLH</sub>	Propagation delay time, low to high output			3.0	4.0	ns
t <sub>PHL</sub>	Propagation delay time, high to low output	$C_1 = 10pF$		3.0	4.0	ns
t <sub>r</sub>	Differential output signal rise time	- Ο <u>Γ</u> – ΤΟΡΙ		0.6	1	ns
t <sub>f</sub>	Differential output signal fall time			0.6	1	ns
t <sub>sk(P)</sub>	Pulse skew ( t <sub>THL</sub> - t <sub>TLH</sub>  ) (Note 1)			0.25		ns
t <sub>PZH</sub>	Propagation delay time, high impedance to high level output			2.5		ns
t <sub>PZL</sub>	Propagation delay time, high impedance to low level output			2.5		ns
t <sub>PHZ</sub>	Propagation delay time, high level to high impedance output			7		ns
t <sub>PLZ</sub>	Propagation delay time, low level to high impedance output			4		ns

Note 1:  $t_{sk(P)}$  is the magnitude of the time difference between the high to low and low to high propagation delay times at an output

Note 2:  $t_{sk(O)}$  is the magnitude of the time difference between the output of a single device with all their inputs connected together.

Note 3: t<sub>sk(PP)</sub> is the magnitude of the difference between any specified terminals of two devices when both devices operate with the same supply voltages, same temperature, and have identical packages and test circuit

## 4 Typical performance characteristics

(Unless otherwise specified  $T_J = 25$ °C)

Figure 2. Output current vs output high voltage for receiver

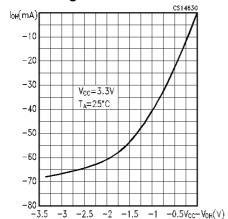


Figure 4. Output current vs output high

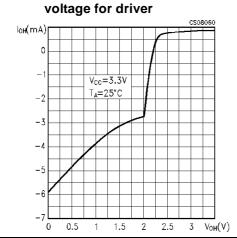


Figure 6. High to low propagation delay time for receiver

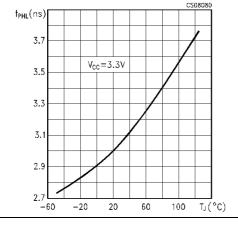


Figure 3. Output current vs output low voltage for receiver

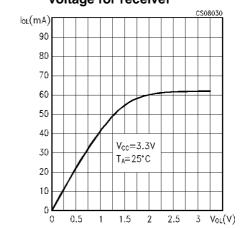


Figure 5. Output current vs output low voltage for driver

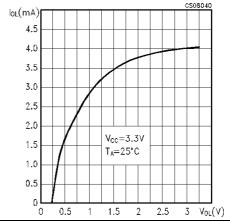
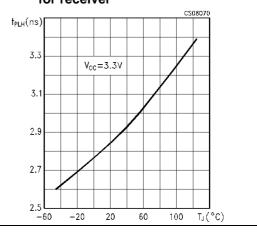
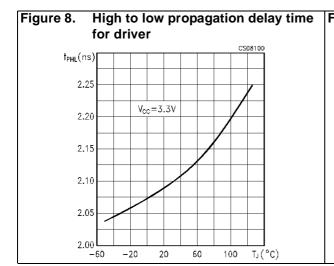
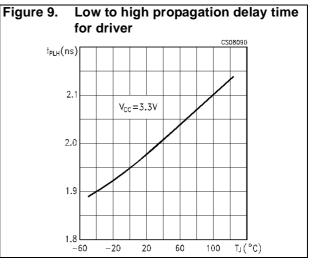


Figure 7. Low to high propagation delay time for receiver







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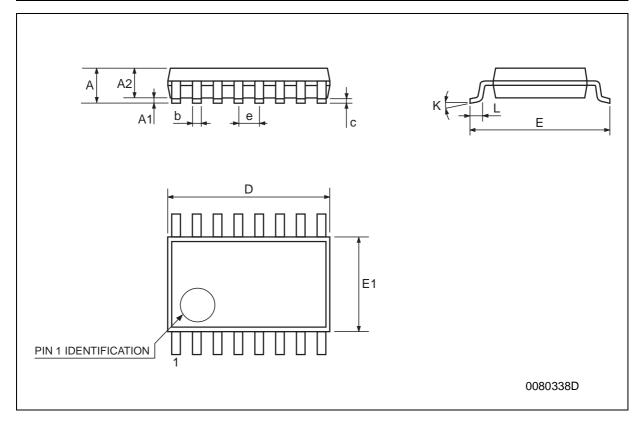
## 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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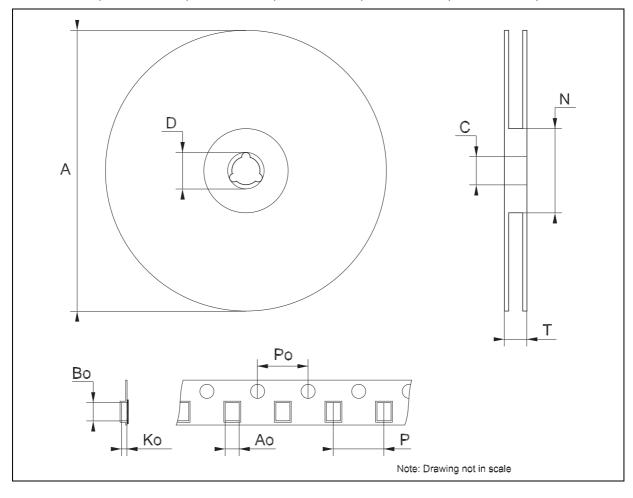
## **TSSOP16 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
С	0.09		0.20	0.004		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
е		0.65 BSC			0.0256 BSC	
К	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



## Tape & Reel TSSOP16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			330			12.992
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
Т			22.4			0.882
Ao	6.7		6.9	0.264		0.272
Во	5.3		5.5	0.209		0.217
Ko	1.6		1.8	0.063		0.071
Po	3.9		4.1	0.153		0.161
Р	7.9		8.1	0.311		0.319



Revision history STLVDS050

# 6 Revision history

Table 11. Revision history

Date	Revision	Changes
22-Mar-2006	4	Order codes has been updated and new template.

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